VCNL4200

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High Sensitivity Long Distance Proximity and Ambient Light Sensor With I²C Interface



LINKS TO ADDITIONAL RESOURCES

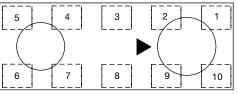


DESCRIPTION

VCNL4200 integrates a high sensitivity long distance proximity sensor (PS), ambient light sensor (ALS), and 940 nm IRED into one small package. It incorporates photodiodes, amplifiers, and analog to digital converting circuits into a single chip using a CMOS process. The 16-bit high resolution ALS offers excellent sensing capabilities with sufficient selections to fulfill most applications whether a dark or high transparency lens design. VCNL4200 offers individual programmable high and low threshold interrupt features for the best utilization of resources and power saving on the microcontroller. For the 12-bit / 16-bit proximity sensing function, VCNL4200 has a built-in intelligent cancellation scheme that eliminates background light issues. The persistence feature prevents false judgment of proximity sensing due to ambient light noise.

The adoption of the patented FiltronTM technology achieves the closest ambient light spectral sensitivity to real human eye responses. VCNL4200 provides excellent temperature compensation capability for keeping the output stable under changing temperature. ALS and PS functions are easily operated via the simple command format of I²C (SMBus compatible) interface protocol. Operating voltage ranges from 2.5 V to 3.6 V.

PIN DEFINITION



Top View

1	GND	6	LED+
2	LED_CATHODE	7	NC
3	V _{DD}	8	INT
4	NC	9	SDAT
5	LED-	10	SCLK

FEATURES

- Package type: surface-mount
- Dimensions (L x W x H in mm): 8.0 x 3.0 x 1.8
- Integrated modules: infrared emitter (IRED), ambient light sensor (ALS), proximity sensor (PS), and signal conditioning IC
- Operates ALS and PS in parallel structure
- FiltronTM technology adoption for robust background light cancellation
- COMPLIANT HALOGEN FREE GREEN (5-2008)

RoHS

- Supports low transmittance (dark) lens design
- Temperature compensation: -40 °C to +85 °C
- Low power consumption I²C (SMBus compatible) interface
- Floor life: 168 h, MSL 3, according to J-STD-020
- Output type: I²C bus (ALS / PS)
- Operation voltage: 2.5 V to 3.6 V
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

PROXIMITY FUNCTION

- Immunity to red glow (940 nm IRED)
- Intelligent background light cancellation
- Smart persistence scheme to reduce PS response time
- Proximity distance up to 1.5 m

AMBIENT LIGHT FUNCTION

- Fluorescent light flicker immunity
- · Spectrum close to real human eye responses
- Selectable maximum detection range (197 / 393 / 786 / 1573) lux with highest sensitivity 0.003 lux/step

INTERRUPT

- Programmable interrupt function for ALS and PS with upper and lower thresholds
- Adjustable persistence to prevent false triggers for ALS and PS

APPLICATIONS

- Presence detection to activate displays in printers, copiers, and home appliances
- · Collision detection in robots and toys
- Proximity sensing and lighting control in offices, corridors and public buildings
- · Parking space availability in lots and garages
- · Proximity detection in lavatory appliances
- <u>Hygienic applications</u>

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For technical questions, contact: consumersensors@vishay.com

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DD	СТ	CUI	DV

PRODUC	PRODUCT SUMMARY											
PART NUMBER	OPERATING RANGE (mm)	OPERATING VOLTAGE RANGE (V)	I ² C BUS VOLTAGE RANGE (V)	IRED PULSE CURRENT (mA)	AMBIENT LIGHT RANGE (lx)	AMBIENT LIGHT RESOLUTION (Ix)	OUTPUT CODE	ADC RESOLUTION PROXIMITY / AMBIENT LIGHT				
VCNL4200	0 to 1500	2.5 to 3.6	1.8 to 3.6	800 (1)	0.003 to 1573	0.003	16 bit, l ² C	12 bit / 16 bit				

Note

⁽¹⁾ Maximum allowed current for VCNL4200 internal IRED

ORDERING INFORMATION								
ORDERING CODE	PACKAGING	VOLUME ⁽¹⁾ PIN NUMBER		REMARKS				
VCNL4200	Tape and reel	MOQ: 2500 pcs	10	8.0 mm x 3.0 mm x 1.8 mm				

Note

⁽¹⁾ MOQ: minimum order quantity

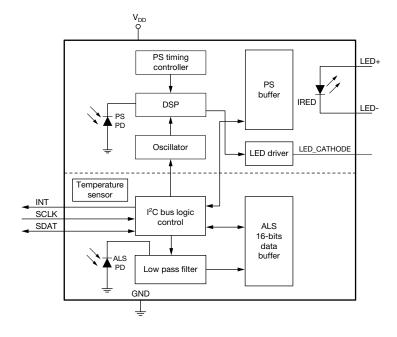
ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)									
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT				
Supply voltage		V _{DD}	-	5.0	V				
Operation temperature range		T _{amb}	-40	+85	°C				
Storage temperature range		T _{stg}	-40	+100	°C				

RECOMMENDED OPERATING CONDITIONS (T _{amb} = 25 °C, unless otherwise specified)									
PARAMETER	TEST CONDITION	SYMBOL	MIN.	MAX.	UNIT				
Supply voltage		V _{DD}	2.5	3.6	V				
Operation temperature range		T _{amb}	-40	+85	°C				
I ² C bus operating frequency		f _(I2CCLK)	10	400	kHz				

PIN DESCRIPTIONS	PIN DESCRIPTIONS										
PIN ASSIGNMENT	SYMBOL	TYPE	FUNCTION								
1	GND	I	Ground								
2	LED_CATHODE	I	IRED cathode connection								
3	V _{DD}	I	Power supply input								
4	NC	-	No connection								
5	LED-	0	IRED cathode								
6	LED+	I	IRED anode								
7	NC	-	No connection								
8	INT	0	Interrupt pin								
9	SDAT	I / O (open drain)	I ² C data bus data input / output								
10	SCLK	I	l ² C digital bus clock input								



BLOCK DIAGRAM



PARAMETER		TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage			V _{DD}	2.5	-	3.6	V
		With an external FET	M	3.8	-	5.5	V
Supply voltage for IRE	:D	Direct connection to the internal driver	V _{IRED}	2.6	-	5	v
Supply current		Excluded LED driving	I _{DD}	-	350	-	μA
Shutdown current		Light condition = dark, V _{DD} = 3.3 V	I _{DD} (SD)	-	0.2	-	μA
ALS shut down		ALS disable, PS enable	I _{ALSSD}	-	300	-	μA
PS shut down		ALS enable, PS disable	I _{PSSD}	-	213	-	μA
	Logic high	N 0.0 M	V _{IH}	1.5	-	-	V
12C aignal innut	Logic low	V _{DD} = 3.3 V	V _{IL}	-	-	0.8	v
I ² C signal input	Logic high	N 0.6 M	V _{IH}	1.4	-	-	v
	Logic low	$V_{DD} = 2.6 V$	V _{IL}	-	-	0.6	v
Peak sensitivity wavel	ength of ALS		λ _p	-	550	-	nm
Peak sensitivity wavel	ength of PS		λ _{pps}	-	940	-	nm
Full ALS counts		16-bit resolution		-	-	65 535	steps
Full PS counts		12-bit / 16-bit resolution		-	-	4095/65535	steps
Detectoble intereity	Minimum	IT = 400 ms, V_{DD} = 3.3 V, 1 step ⁽¹⁾⁽²⁾		-	0.003	-	lx
Detectable intensity	Maximum	IT = 50 ms, V _{DD} = 3.3 V, 65 535 steps ⁽¹⁾⁽²⁾		-	1573	-	IX
ALS dark offset		IT = 50 ms, V_{DD} = 3.3 V, normal sensitivity ⁽¹⁾		0	-	3	steps
Operating temperature	e range		T _{amb}	-40	-	+85	°C
IRED driving current		(3)		-	-	800	mA

Notes

⁽¹⁾ Light source: white LED

⁽²⁾ Maximum detection range to ambient light can be determined by ALS refresh time adjustment. Refer to table 17 "ALS Resolution and Maximum Detection Range"

(3) Based on IRED on / off duty ratio = 1/160, 1/320, 1/640, and 1/1280. The circuitry should use an external MOSFET as shown with Fig.11. Please see also the Application Note "Designing the VCNL4200 into an Application" (www.vishay.com/doc?84327)

VCNL4200



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I ² C BUS TIMING CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)									
PARAMETER	SYMBOL	STANDA	RD MODE	FAST MODE					
PARAMETER	STNIBOL	MIN.	MAX.	MIN.	MAX.	UNIT			
Clock frequency	f _(SMBCLK)	10	100	10	400	kHz			
Bus free time between start and stop condition	t _(BUF)	4.7	-	1.3	-	μs			
Hold time after (repeated) start condition; after this period, the first clock is generated	t _(HDSTA)	4.0	-	0.6	-	μs			
Repeated start condition setup time	t _(SUSTA)	4.7	-	0.6	-	μs			
Stop condition setup time	t _(SUSTO)	4.0	-	0.6	-	μs			
Data hold time	t _(HDDAT)		3450	-	900	ns			
Data setup time	t _(SUDAT)	250	-	100	-	ns			
I ² C clock (SCK) low period	t _(LOW)	4.7	-	1.3	-	μs			
I ² C clock (SCK) high period	t _(HIGH)	4.0	-	0.6	-	μs			
Clock / data fall time	t _(F)	-	300	-	300	ns			
Clock / data rise time	t _(R)	-	1000	-	300	ns			

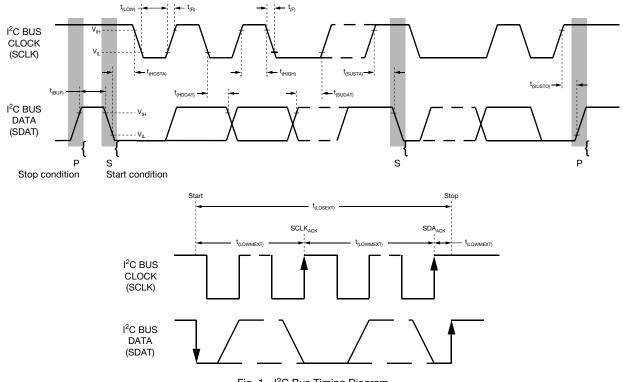


Fig. 1 - I²C Bus Timing Diagram

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PARAMETER TIMING INFORMATION

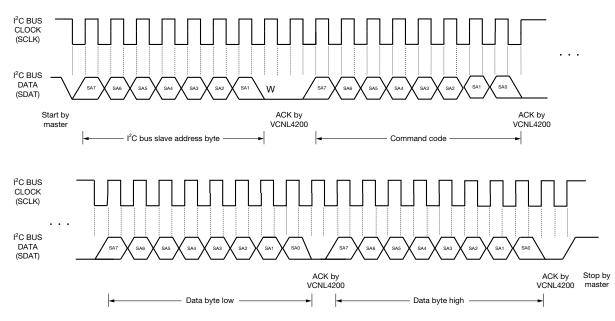


Fig. 2 - I²C Bus Timing for Sending Word Command Format

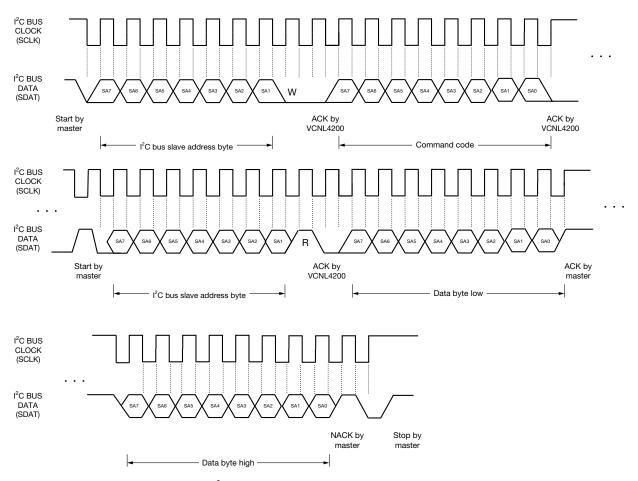


Fig. 3 - I²C Bus Timing for Receiving Word Command Format



TYPICAL PERFORMANCE CHARACTERISTICS ($T_{amb} = 25 \text{ °C}$, unless otherwise specified)

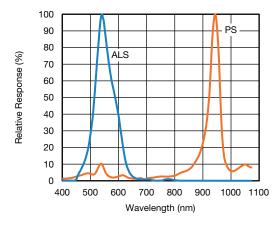


Fig. 4 - Normalized Spectral Response

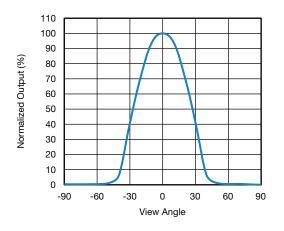


Fig. 5 - ALS Normalized Output vs. View Angle

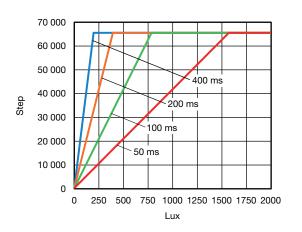


Fig. 6 - ALS Refresh Time vs. Maximum Detection Range

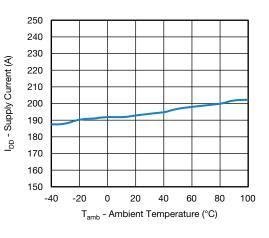


Fig. 7 - I_{DD} vs.Temperature

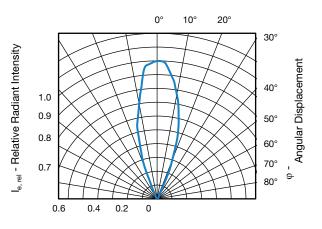


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement

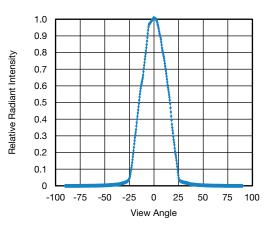


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement (Cartesian view)

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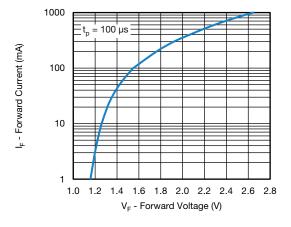


Fig. 10 - Forward Current vs. Forward Voltage

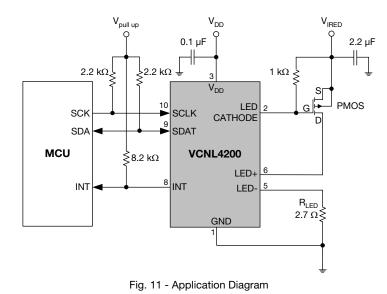
APPLICATION INFORMATION

Pin Connection with the Host

VCNL4200 is a cost effective solution of a long distance proximity sensor with I²C interface. The standard serial digital interface easily accesses "light intensity" by using simple calculations.

Application circuitry below shows the added MOSFET which is driven by the ASIC's pin 2. A 1 k Ω pull-up resistor needs to be added here. The R_{LED} defines the current through the IRED. A small 0.1 μ F is sufficient at V_{DD} for power supply noise rejection, but a 2.2 μ F should be placed at V_{IRED} to provide the energy for the IRED.

For the l²C bus design, the pull-up voltage refers to the I/O specification of the baseband due to its "open drain" design. The pull-high resistors for the l²C bus lines are recommended to be $\ge 2.2 \text{ k}\Omega$.



Notes

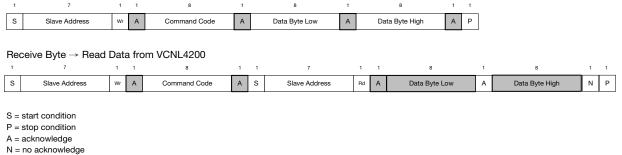
- V_{DD} range: 2.5 V to 3.6 V and V_{IRED} is recommended 5.0 V
- Power path of V_{DD} and V_{IRED} should be routed separately up to stable power source
- The R_{LED} resister value should be evaluated within ready-made application and the current through VCNL4200-internal IRED should not exceed 800 mA
- LED_I programmed to lowest value of 50 mA is enough to drive the FET



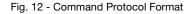
Digital Interface

VCNL4200 applies single 7-bit slave address 0x51 (HEX) following I²C protocol. All operations can be controlled by the command register. The simple command structure helps users easily program the operation setting and latch the light data from VCNL4200. As fig. 12 shows, VCNL4200's I²C command format is simple for read and write operations between VCNL4200 and the host. The white sections indicate host activity and the gray sections indicate VCNL4200's acknowledgement of the host access activity. Write word and read word protocols are suitable for accessing registers particularly for 16-bit ALS data and 12-bit / 16-bit PS data. Interrupt can be cleared by reading data out from register: INT_Flag.





Shaded area = VCNL4200 acknowledge



Function Description

VCNL4200 applies a 16-bit high resolution ALS that provides the best ambient light sensing capability up to 0.003 lx/step which works well under a low transmittance lens design (dark lens). Please also note from Fig. 5, that the viewing angle of the ALS is very small, so accurate values will only be measured, if the light source is directly above the sensor. A flexible interrupt function of ALS (register: ALS_CONF) is also supported. The INT signal will not be asserted by VCNL4200 if the ALS value is not over high INT threshold window level, or lower than low INT threshold window level of ALS. As long as the ALS INT is asserted, the host can read the data from VCNL4200.

For proximity sensor function, VCNL4200 supports different kinds of mechanical design to achieve the best proximity detection performance for any color object. The basic PS function settings, such as duty ratio, integration time, interrupt, and PS enable / disable and persistence, are handled by the register: PS_CONF1. Duty ratio controls the PS response time. Integration time represents the duration for which the detector is sensitive to be reflected light. The interrupt is asserted when the PS detection goes over the high threshold level setting (register: PS_THDH) or lower than low threshold (register: PS_THDL). If the interrupt function is enabled, the host reads the PS output data from VCNL4200 that saves host from periodically reading PS data. Additionaly INT flag (register: INT_Flag) indicates the behavior of INT triggered under different conditions. PS persistence (PS_PERS) sets up the PS INT asserted conditions as long as the PS output value continually exceeds the threshold level. PS_MS enables the interrupt logic mode, where the interrupt is triggered by surpassing the high threshold and is automatically reset when the signal falls below the low threshold.



Descriptions of each of these settings are shown in table 1.

COMMAND CODE	REGISTER NAME	R/W	DEFAULT VALUE	FUNCTION DESCRIPTION
00H_L	ALS_CONF	R/W	01H	ALS integration time, persistence, interrupt, and function enable / disable
00H_H	Reserved	R/W	01H	Reserved
01H_L	ALS_THDH_L	R/W	00H	ALS high interrupt threshold, LSB
01H_H	ALS_THDH_H	R/W	00H	ALS high interrupt threshold, MSB
02H_L	ALS_THDL_L	R/W	00H	ALS low interrupt threshold, LSB
02H_H	ALS_THDL_H	R/W	00H	ALS low interrupt threshold, MSB
03H_L	PS_CONF1	R/W	01H	PS duty ratio, integration time, persistence, and PS enable / disable
03H_H	PS_CONF2	R/W	00H	PS_HD, PS interrupt trigger method
04H_L	PS_CONF3	R/W	00H	PS multi pulse, active force mode, enable sunlight cancellation
04H_H	PS_MS	R/W	00H	PS mode selection, sunlight capability, sunlight protection mode
05H_L	PS_CANC_L	R/W	00H	PS cancellation level setting, LSB
05H_H	PS_CANC_H	R/W	00H	PS cancellation level setting, MSB
06H_L	PS_THDL_L	R/W	00H	PS low interrupt threshold setting, LSB
06H_H	PS_THDL_H	R/W	00H	PS low interrupt threshold setting, MSB
07H_L	PS_THDH_L	R/W	00H	PS high interrupt threshold setting, LSB
07H_H	PS_THDH_H	R/W	00H	PS high interrupt threshold setting, MSB
08H_L	PS_Data_L	R	00H	PS LSB output data
08H_H	PS_Data_H	R	00H	PS MSB output data
09H_L	ALS_Data_L	R	00H	ALS LSB output data
09H_H	ALS_Data_H	R	00H	ALS MSB output data
0AH_L	White_Data_L	R	00H	White LSB output data
0AH_H	White_Data_H	R	00H	White MSB output data
0BH_L	Reserved	R	00H	Reserved
0BH_H	Reserved	R	00H	Reserved
0CH_L	Reserved	R	00H	Reserved
0CH_H	Reserved	R	00H	Reserved
0DH_L	Reserved	R	00H	Reserved
0DH_H	INT_Flag	R	00H	ALS, PS interrupt flags
0EH_L	ID_L	R	58H	Device ID LSB
0EH_H	ID_H	R	10H	Device ID MSB



Command Register Format

VCNL4200 provides an 8-bit command register for ALS and PS controlling independently. The description of each command format is shown in following tables.

TABLE 2 - REGISTER: ALS_CONF DESCRIPTION											
REGISTER NAME			COMMAND CODE: 00H_L (00H DATA BYTE LOW)								
Command	Bit	7	6	5	4	3	2	1	0		
ALS_CONF		COMMAND CODE: 00H_L (00H DATA BYTE LOW)									
Command	Bit				Descr	ription					
ALS_IT	7:6		(0 : 0) = 50 ms; (0 : 1) = 100 ms; (1 : 0) = 200 ms; (1 : 1) = 400 ms ALS integration time setting, longer integration time has higher sensitivity								
ALS_INT_SWITCH	5	ALS interru	pt switch, 0 =	ALS channel	interrupt, 1 =	white channe	el interrupt				
Reserved	4	Default = 0	, reserved								
ALS_PERS	3:2		0:0) = 1, (0:1) = 2, (1:0) = 4, (1:1) = 8 ALS interrupt persistence setting								
ALS_INT_EN	1	0 = ALS int) = ALS interrupt disable, 1 = ALS interrupt enable								
ALS_SD	0	0 = ALS po	wer on, 1 = A	LS shut dowr	1						

TABLE 3 - REGISTER: RESERVE COMMAND DESCRIPTION			
Reserved		COMMAND CODE: 00H_H (00H DATA BYTE HIGH)	
Command	mand Bit Description		
Reserved	7:0	Must be kept at 01H to achieve the stated I _{DD}	

TABLE 4 - REGISTER ALS_THDH_L AND ALS_THDH_H DESCRIPTION				
ALS_THDH_L ALS_THDH_H		COMMAND CODE: 01H_L (01H DATA BYTE LOW) COMMAND CODE: 01H_H (01H DATA BYTE HIGH)		
Register	Bit	Description		
ALS_THDH_L	7:0	00H to FFH, ALS high interrupt threshold, LSB		
ALS_THDH_H	7:0	00H to FFH, ALS high interrupt threshold, MSB		

TABLE 5 - REGISTER: ALS_THDL_L AND ALS_THDL_H DESCRIPTION				
ALS_THDL_L ALS_THDL_H		COMMAND CODE: 02H_L (02H DATA BYTE LOW) COMMAND CODE: 02H_H (02H DATA BYTE HIGH)		
Register	Bit	Description		
ALS_THDL_L	7:0	00H to FFH, ALS low interrupt threshold, LSB		
ALS_THDL_H	7:0	00H to FFH, ALS low interrupt threshold, MSB		

TABLE 6 - REGISTER: PS_CONF1 DESCRIPTION					
PS_CONF1		COMMAND CODE: 03H_L (03H DATA BYTE LOW)			
Command	Bit	Description			
PS_Duty	7:6	: 0) = 1/160, (0 : 1) = 1/320, (1 : 0) = 1/640, (1 : 1) = 1/1280 S IRED on / off duty ratio setting			
PS_PERS	5:4	(0:0) = 1, (0:1) = 2, (1:0) = 3, (1:1) = 4 PS interrupt persistence setting			
PS_IT	3:1	(0:0:0) = 1T, $(0:0:1) = 1.5T$, $(0:1:0) = 2T$, $(0:1:1) = 4T$, $(1:0:0) = 8T$, $(1:0:1) = 9T$, $(1:1:1:0) = reserved$, $(1:1:1) = reserved$			
PS_SD	0	0 = PS power on, 1 = PS shut down			



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TABLE 7 - REGISTER: PS_CONF2 DESCRIPTION				
PS_CONF2		COMMAND CODE: 03H_H (03H DATA BYTE HIGH)		
Command	Bit	Description		
Reserved	7:4	Reserved		
PS_HD	3	3 0 = PS output is 12 bits, 1 = PS output is 16 bits		
Reserved	2	Reserved		
PS_INT	1:0	Proximity interrupt configuration (0 : 0) = interrupt disable, (0 : 1) = trigger by closing, (1 : 0) = trigger by away, (1 : 1) = trigger by closing and away		

TABLE 8 - REGISTER: PS_CONF3 DESCRIPTION				
PS_CONF3		COMMAND CODE: 04H_L (04H DATA BYTE LOW)		
Command	Bit	Description		
Reserved	7	Default = 0, reserved		
PS_MPS	6:5	Proximity multi pulse numbers (0:0) = 1, (0:1) = 2, (1:0) = 4, (1:1) = 8 multi pulses		
PS_SMART_PERS	4	Proximity sensor smart persistence 0 = disable; 1 = enable		
PS_AF	3	0 = active force mode disable (normal mode), 1 = active force mode enable		
PS_TRIG	2	0 = no PS active force mode trigger, 1 = trigger one time cycle VCNL4200 output one cycle data every time host writes in "1" to sensor. The state returns to "0" automatically.		
PS_SC_ADV	1	0 = typical sunlight immunity; 1 = 2 x typical sunlight immunity		
PS_SC_EN	0	PS sunlight cancel enable setting, 1 = sunlight cancellation function enable		

TABLE 9 - REGISTER: PS_MS DESCRIPTION			
Reserved		COMMAND CODE: 04H_H (04H DATA BYTE HIGH)	
Command Bit Description		Description	
Reserved	7:6	Default = 0, reserved	
PS_MS	5	Proximity operation mode 0 = proximity normal operation with interrupt function, 1 = proximity detection logic output mode enab	
PS_SP	4	0 = typical sunlight capability, 1 = 1.5 x typical sunlight capability	
PS_SPO	3	0 = output is 00h in sunlight protect mode, 1 = output is FFh in sunlight protect mode	
LED_I	2:0	(0 : 0 : 0) = 50 mA, (0 : 0 : 1) = 75 mA, (0 : 1 : 0) = 100 mA, (0 : 1 : 1) = 120 mA, (1 : 0 : 0) = 140 mA, (1 : 0 : 1) = 160 mA, (1 : 1 : 0) = 180 mA, (1 : 1 : 1) = 200 mA	

TABLE 10 - REGISTER: CANC_L AND CANC_H DESCRIPTION					
Reserved COMMAND CODE: 05H_L (05H DATA BYTE LOW)					
Register	Bit	Description			
PS_CANC_L	7:0	00H to FFH, PS cancellation level setting, LSB			
PS_CANC_H	7:0	00H to FFH, PS cancellation level setting, MSB			

TABLE 11 - REGISTER: PS_THDL_L AND PS_THDL_H DESCRIPTION				
PS_THDL_L PS_THDL_H		COMMAND CODE: 06H_L (06H DATA BYTE LOW) COMMAND CODE: 06H_H (06H DATA BYTE HIGH)		
Register	gister Bit Description			
PS_THDL_L	7:0	00H to FFH, PS low interrupt threshold setting, LSB		
PS_THDL_H	7:0	00H to FFH, PS low interrupt threshold setting, MSB		



TABLE 12 - REGISTER: PS_THDH_L AND PS_THDH_H DESCRIPTION				
PS_THDH_L PS_THDH_H		COMMAND CODE: 07H_L (07H DATA BYTE LOW) COMMAND CODE: 07H_H (07H DATA BYTE HIGH)		
Register	Bit	Description		
PS_THDH_L	7:0	00H to FFH, PS high interrupt threshold setting, LSB		
PS_THDH_H	7:0	00H to FFH, PS high interrupt threshold setting, MSB		

TABLE 13 - READ OUT REGISTER DESCRIPTION					
REGISTER	COMMAND CODE		DESCRIPTION		
PS_Data_L	08H_L (08H data byte low)	7:0	00H to FFH, PS LSB output data		
PS_Data_H	08H_H (08H data byte high)	7:0	00H to FFH, PS MSB output data		
ALS_Data_L	09H_L (09H data byte low)	7:0	00H to FFH, ALS LSB output data		
ALS_Data_H	09H_H (09H data byte high)	7:0	00H to FFH, ALS MSB output data		
White_Data_L	0AH_L (0AH data byte low)	7:0	00H to FFH, white LSB output data		
White_Data_H	0AH_H (0AH data byte high)	7:0	00H to FFH, white MSB output data		
Reserved	0BH_L (0BH data byte low)	7:0	Default = 00H		
Reserved	0BH_H (0BH data byte low)	7:0	Default = 00H		
Reserved	0CH_L (0CH data byte low)	7:0	Default = 00H		
Reserved	0CH_H (0CH data byte low)	7:0	Default = 00H		
Reserved	0DH_L (0DH data byte low)	7:0	Default = 00H		
INT_Flag	0DH_H (0DH data byte high)	7 6 5 4 3 2 1 0	PS_UPFLAG PS code saturation flag PS_SPFLAG PS enter sunlight protection flag ALS_IF_L, ALS crossing low THD INT trigger event ALS_IF_H, ALS crossing high THD INT trigger event Default = 0, reserved Default = 0, reserved PS_IF_CLOSE, PS rise above PS_THDH INT trigger event PS_IF_AWAY, PS drop below PS_THDL INT trigger event		
ID_L	0x0EH_L (0x0EH data byte low)	7:0	58H for MP version sample, device ID LSB byte		
ID_H	0x0EH_H (0x0EH data byte high)	7:6 5:4 3:0	(0 : 0) (0 : 1) slave address = 0x51 (7-bit) Version code (0 : 0 : 0 : 0) = ES1, device ID MSB byte		

Adjustable Sampling Time

VCNL4200's embedded LED driver drives the external IRED with the "LED_CATHODE" pin by a pulsed duty ratio. The IRED on / off duty ratio can be programmable by I²C command at register: PS_Duty is related to the current consumption and PS response time. The higher the duty ratio selected, the faster response time achieved with higher power consumption. Please see also the application note: "Designing VCNL4200 Into an Application".



Threshold Window Setting

• ALS Threshold Window Setting (Applying ALS INT)

Register: ALS_THDH_L and ALS_THDH_H define 16-bit ALS high threshold data for LSB byte and MSB byte. Register: ALS_THDL_L and ALS_THDL_H define 16-bit ALS low threshold data for LSB byte and MSB byte. As long as ALS INT function is enabled, INT will be asserted once the ALS data exceeds ALS_THDH or goes below ALS_THDL. To easily define the threshold range, multiply the value of the resolution (lx/step) by the threshold level (refer table 14)

TABLE 14 - ALS RESOLUTION AND MAXIMUM DETECTION RANGE				
ALS_IT SENSITIVITY MAXIMUM DETECTION				
ALS_IT (7 : 6)	INTEGRATION TIME	(lx/step)	RANGE (lx)	
(0, 0)	50 ms	0.024	1573	
(0, 1)	100 ms	0.012	786	
(1, 0)	200 ms	0.006	393	
(1, 1)	400 ms	0.003	197	

• ALS Persistence

The ALS INT is asserted as long as the ALS value is higher or lower than the threshold window when ALS_PERS (1 / 2 / 4 / 8 times) is set to one time. If ALS_PERS is set to four times, then the ALS INT will not be asserted if the ALS value is not over (or lower) than the threshold window for four continued refresh times (integration time)

• Programmable PS Threshold

VCNL4200 provides both high and low thresholds 8-bit data setting for proximity sensor. (register: PS_THDL, PS_THDH) that fulfills different mechanical designs with the best proximity detection capability for any kind of objects

PS Persistence

The PS persistence function (PS_PERS 1 / 2 / 3 / 4) helps to avoid false trigger of the PS INT. For example, if $PS_PERS = 3$ times, the PS INT will not be asserted unless the PS value is greater than the PS threshold (PS1_THDH) value for three periods of time continuously

Data Access

All VCNL4200 command registers are readable. To access 16-bit high resolution ALS output data, it is suitable to use read word protocol to read out data by just one command at register: ALS_Data_L and ALS_Data_H. To represent the 16-bit data of ALS, it has to apply two bytes. One byte is for LSB, and the other byte is for MSB as shown in table 18. In terms of reading out 8-bit PS data, host just need to access register: PS_Data.

TABLE 15 - 16-BIT ALS DATA FORMAT																
		VCNL4200														
Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Register		ALS_Data_H							ALS_Data_L							

Interrupt (INT)

VCNL4200 has ALS and PS interrupt feature operated by a single pin "INT". The purpose of the interrupt feature is to actively inform the host once INT has been asserted. With the interrupt function applied, the host does not need to constantly poll data from the sensor, but to only read data from the sensor when receiving interrupt request from the sensor. As long as the host enables ALS interrupt (register: ALS_INT_EN) or PS interrupt (register: PS_INT) function, the level of INT pin (pin 8) is able to be pulled low once INT asserted. All of registers are accessible even INT is asserted.

ALS INT asserted when ALS value crosses over the value set by register: ALS_THDH or is lower than the value set by register: ALS_THDL.

PS INT asserted when PS value crosses over the value set by register: PS_THDH or is lower than the value set by register: PS_THDL.

Interrupt Flag

Register: INT_Flag represents all of interrupt trigger status for ALS and PS. Any flag value changes from "0" to "1" state, the level of INT pin will be pulled low. As long as host reads INT_Flag data, the bit will change from "1" state to "0" state after reading out. The INT level will be returned to high afterwards.

Rev. 1.8, 17-Mar-2025 13 Document Number: 84430 For technical questions, contact: <u>consumersensors@vishay.com</u> THIS DOCUMENT IS SUBJECT TO CHANGE WITHOUT NOTICE. THE PRODUCTS DESCRIBED HEREIN AND THIS DOCUMENT



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PROXIMITY DETECTION LOGIC OUTPUT MODE

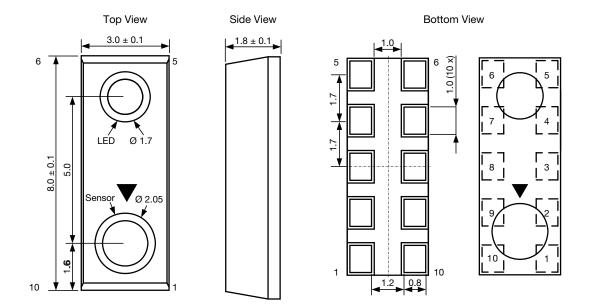
VCNL4200 provides a proximity detection logic output mode that uses INT pin as a proximity detection logic high / low output (register: PS_MS). When this mode is selected, the PS output (INT/P_{OUT}) is pulled low when an object is close to being detected and returned to level high when the object moves away. Register: PS_THDH / PS_THDL defines how sensitive PS detection is.

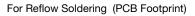
One thing to be noted is that whenever proximity detection logic mode applied, INT pin is only used as a logic high / low output. If host would like to use ALS with INT function, register: PS_MS has to be selected to normal operation mode ($PS_MS = 0$). Meanwhile, host has to simulate the GPIO pin as an INT pin function. If not, host needs to periodically read the state of INT at this GPIO pin.

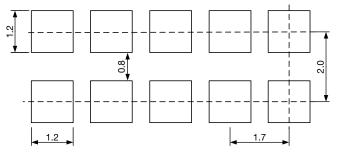
PROXIMITY DETECTION HYSTERESIS

A PS detection hysteresis is important to keep the PS state in a certain range of detection distance. For example, PS INT asserts when PS value over PS_THDH. Host switches on panel backlight and then clears INT. When PS value is less than PS_THDL, host switches off panel backlight. Any PS value lower than PS_THDH or higher than PS_THDL PS INT will not be asserted. Host keeps the same state.

PACKAGE INFORMATION in millimeters







1	GND	6	LED+
2	LED_CATHODE	7	NC
3	VDD	8	INT
4	NC	9	SDAT
5	LED-	10	SCLK

Fig. 13 - VCNL4200 Package Dimensions



APPLICATION CIRCUIT BLOCK REFERENCE

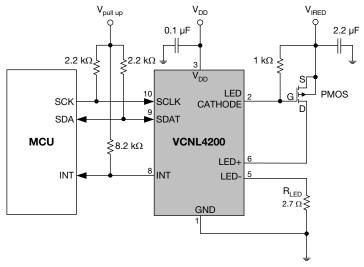


Fig. 14 - VCNL4200 Application Circuit

Notes

- + V_{DD} range: 2.5 V to 3.6 V and V_{IRED} is recommended 5.0 V
- Power path of V_{DD} and V_{IRED} should be well separated and supply source for V_IRED should be stable enough for the high peak current
- The R_{LED} resistor value is reference for test stage, it should be adjusted again for the product usage basing on the power and the lens final design
- The FET may be any small device, e.g. a Si2301
- LED_I programmed to lowest value of 50 mA is enough to drive the FET
- If not that high detection distance is needed the application note "Designing the VCNL4200 Into an Application" (www.vishay.com/doc?84327) shows a circuitry without this added FET

RECOMMENDED STORAGE AND REBAKING CONDITIONS						
PARAMETER	CONDITIONS	MIN.	MAX.	UNIT		
Storage temperature		5	50	°C		
Relative humidity		-	60	%		
Open time		-	168	h		
Total time	From the date code on the aluminized envelope (unopened)	-	12	months		
Rebaking	Tape and reel: 60 °C	-	22	h		
nebakiliy	Tube: 60 °C	-	22	h		



RECOMMENDED INFRARED REFLOW

Soldering conditions which are based on J-STD-020 C.

IR REFLOW PROFILE CONDITION							
PARAMETER	CONDITIONS	TEMPERATURE	TIME				
Peak temperature		255 °C + 0 °C / - 5 °C (max.: 260 °C)	10 s				
Preheat temperature range and timing		150 °C to 200 °C	60 s to 180 s				
Timing within 5 °C to peak temperature			10 s to 30 s				
Timing maintained above temperature / time		217 °C	60 s to 150 s				
Timing from 25 °C to peak temperature			8 min (max.)				
Ramp-up rate		3 °C/s (max.)					
Ramp-down rate		6 °C/s (max.)					

Recommend Normal Solder Reflow is 235 °C to 255 °C.

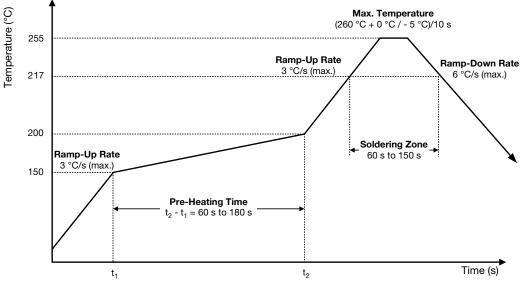


Fig. 15 - VCNL4200 Solder Reflow Profile Chart

RECOMMENDED IRON TIP SOLDERING CONDITION AND WARNING HANDLING

- 1. Solder the device with the following conditions:
 - 1.1. Soldering temperature: 400 °C (max.)
 - 1.2. Soldering time: 3 s (max.)
- 2. If the temperature of the method portion rises in addition to the residual stress between the leads, the possibility that an open or short circuit occurs due to the deformation or destruction of the resin increases
- 3. The following methods: VPS and wave soldering, have not been suggested for the component assembly
- 4. Cleaning method conditions:
 - 4.1. Solvent: methyl alcohol, ethyl alcohol, isopropyl alcohol
 - 4.2. Solvent temperature < 45 °C (max.)
 - 4.3. Time: 3 min (min.)



TAPE PACKAGING INFORMATION in millimeters

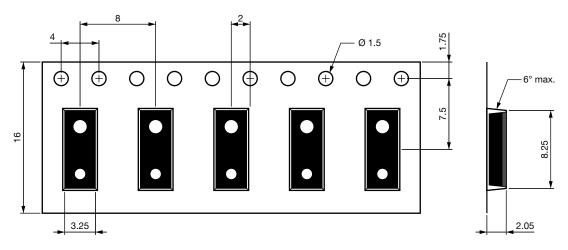


Fig. 16 - Package Carrier Tape

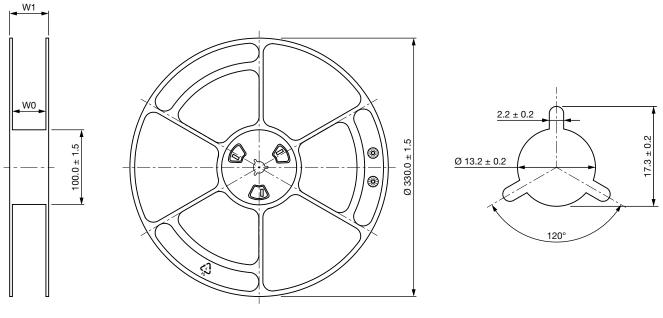


Fig. 17 - Reel Dimensions



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